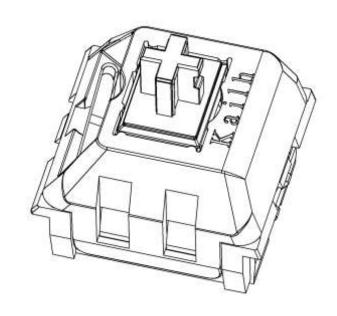




Document Number:

KH-PS1801-02

Product Specification



		T:41-			
CPG	151101D234	PG1511 Keyboard Switch			
ECN	Release and Revision Description:	Prepared By /Date:	Checked By/Date:	Approved By/Date:	
A — New releasing		YIJINGPING 2019-08-28	HUYUANGFENG 2019-08-28	YIPING 2019-08-28	
		ECN Description:	ECN Release and Revision Description: Prepared By /Date: New releasing YIJINGPING	CPG151101D234 PG1511 Keyboard ECN Release and Revision Description: Prepared By /Date: Checked By/Date: YIJINGPING HUYUANGFENG	



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1. Scope:

This Product Specification covers the requirement of Mechanical Keyboard switch on product performance, test methods and quality assurance provisions.

2. Product Application:

Mainly applied on computer keyboards, cash registers, industrial equipment and Man-Machine interface.

3. Technology Parameters:

Ambient Humidity: 45~85% R.H.; Operating Temperature Range: $-10^{\circ}\text{C} + 70^{\circ}\text{C}$; Storage Temperature Range: $-20^{\circ}\text{C} + 70^{\circ}\text{C}$; Suggested storage period: about 6 months

Require the tin part on the switch terminals should keep good after storage guarantee date

Normal Condition:

Ambient temperature: $20\pm2^{\circ}$ C Relative humidity: $65\%\pm5\%$ R.H.; Air pressure : $86\sim101$ KPa;

Solder Ability: Tim-lead soldering: 245° C $\pm 5^{\circ}$ C $5s\pm 0.5s$;

Lead-free welding : $255^{\circ}C \pm 5^{\circ}C$ $5s \pm 0.5s$;

Withstand Soldering Temperature: Wave soldering: $260\pm5^{\circ}$ C 5 ± 0.5 s;

4. Ratings:

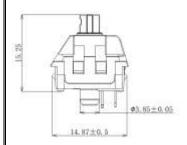
Rating: 12V AC/DC max. 2V DC min. 10mA AC/DC max. 10 µ A DC min;

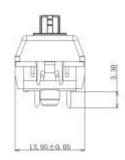
Insulation Resistance: $\geqslant 100M\Omega/DC\ 100V$;

Withstand Voltage: 100V AC 1 Minute;

Mechanical Life: 50,000,000 Cycles. **5. Profile Dimensions:**









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Electrical Performance:

o. Electrical Fertormance:					
Item	Description	Test Condition	Requirement		
6.1	Contact Resistance	Static load: (Operation force)x2, which is applied on the center of Switch stem. Be measured when the switch contact stabilization. Measurement tool: Contact resistance Meter. (1KHz, 20mV,5~50mA) Measured at low current (100mA or less).	200mΩ Max		
6.2	Insulation Resistance	Apply a Voltage of DC 500 V for 1 minute, according to the below method. (1) Between terminals. (2) Between terminal and Body.	100MΩ Min		
6.3	Dielectric withstanding voltage	Apply a Voltage of AC100 V (50~60Hz) for 1 minute, according to the below method. (1) Between terminals. (2) Between terminal and Body.	No evidence of breakdown.		
6.4	Bouncing	Operation speed: 3~4 times/s Oscilloscope Switch Bouncing Test Circuit. D. C. 10V 10mA 10KΩ 0scillo Scope 示波器 Switch Bouncing Test Circuit 抖动测定回路 "ON" "OFF"	Before Life cycle: On:5ms MAX Off: 5ms MAX After Life cycle: On:10ms MAX Off: 10ms MAX		



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7. Mechanical Performance:

lt	Description	Tes Condition	Requirement
7.1	Load Curve	Place the vertical direction of switch operation and gradually increase the load applied to the center of the stem until it stop.	See page 10
7.2	Loading parameter	Place the vertical direction of switch operation and gradually increase the load applied to the center of the stem until it stop. TTF Mounting Surface	See page 10
7.3	Static Strength	A static load of 3kgf shall be applied in the direction of button operation for a period of 60 seconds.	No damage (Electrical) And mechanical)



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	7.4	Stem Pull Strength	Break by a pull force applied opposite to the direction of stem operation.	5kgf Min
	7.5	Shock	Measured by according to the below condition: (1) Acceleration: 80g accelerated speed (2) Cycles of test:3 cycles each in 6 directions, for a total of 18 cycles.	Shall meet No.6, 7.1, 7.2.
7	.6	Life Test	1) D.C.12V 10mA resistance load 2) Operation speed: 5-6 times / s 3) Push force: 150gf 4) Operation number: 50,000,000cycles	Contact resistance: 1Ω Max Bouncing: 10ms Max Operation force and tactile force: Variation rate within $\pm 30\%$

8. Environmental Performance:

Item	Description	Test Condition	Requirement
8.1	Cold test	 (1) Temperature : - 20±2°C (2) Duration of test: 48h (3) Take off a drop water (4) Standard conditions after test : 1 	Contact resistance: 200m Ω Max Shall meet : No. 6.2 to 6.4 No. 7.1 to 7.2



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Na	III KAIHUA EL	ECTRONICS						
8.2	Heat test	 (1) Temperature: 70±2°C (2) Duration of test: 48h (3) Take off a drop water (4) Standard conditions after test: 1h 			Contact resistance: 200m Ω Max Shall meet : No. 6.2 to 6.4 No. 7.1 to 7.2			
8.3	Temperature cycle	(1) Test cycles: 5 cycles (2) Standard condition after test:1h Temperature Duration of test 1 cycle 20±5℃ 1h -20±5℃ 1h 20±5℃ h 70±5℃			Contact resistance: 200m Ω Max Shall meet : No. 6.2 to 6.4 No. 7.1 to 7.2			
8.4	Soldering heat test	Soldering area: 1/2 of PWB thickness. (PWB: T=1.6mm) Soldering temperature: 260±5°C Soldering time: 5±0.5s				Appeara No abno		
8.5	Solder ability	Lead-tin soldering: Soldering temperature: $245\pm5^{\circ}\text{C}$ Soldering time: $5\pm0.5\text{s}$ Lead free soldering: Soldering temperature: $255\pm5^{\circ}\text{C}$ Soldering time: $5\pm0.5\text{s}$				area of i	90% of su mmersed covered b	portion



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	8.6	Humidity test	 (1) Temperature: 60±2℃ (2) relative humidity: 90~95% R.H. (3) Duration of test: 48h (4) Take off a drop water (5) Standard conditions after test: 1h 	Contact resistance: 200m Ω Max Shall meet : No. 6.2 to 6.4 No. 7.1 to 7.2
	8.7	Salt Spray	Apply the following environment to test(Only for contact test) : $ (1) \ \text{Temperature} : \ 35 \pm 5 ^{\circ}\mathbb{C} $ (2) Salt water density: $5 \pm 1 \%$ (3) Duration: 12hours (4) After test, the salt deposit shall be removed by running water.	Appearance: No corrosion spot, no crack, no base plate naked. Contact Resistance: 200 m Ω Max



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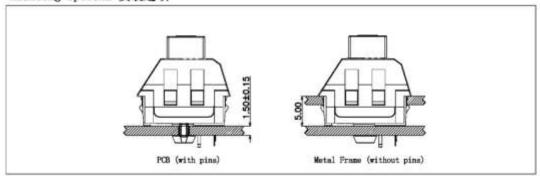
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9. Recommended PCB Layout

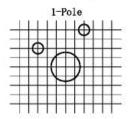
Mounting Options 安装选项

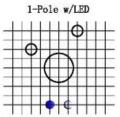


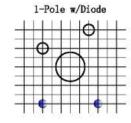
Circuit Board Layouts 电路板布局

Grid line spacing = 1.27mm 网络线间距= 1.27毫米

Keyswitch without fixation pins 按键开关不带定位柱







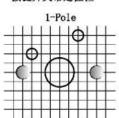


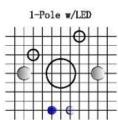
 $\emptyset 3.99 \pm 0.1$

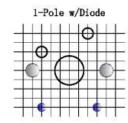
O Ø1.50±0.05

o ∞1.0±0.1

Keyswitch with fixation pins 按键开关带定位柱







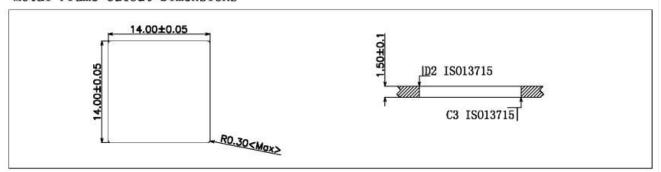


 $\emptyset 3.99 \pm 0.1$

Ø1.70±0.05

Ø1.50±0.05 Ø1.0±0.1

Metal Frame Cutout Dimensions





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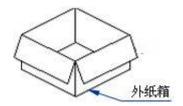
10.Loading Parameter (TT/PT/OT /OF/TF/RF) Specification:

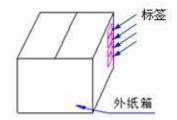
Parameter	Unit	Specification	Remark
FP	mm	15.25±0.2	
OP	mm	14.05±0.7	
PT	mm	1.20±0.50	
OF	gf	70±20	
TF	gf	95±20	
TT	mm	3.5±0.50	

11. Packaging:

Packaging type: Tray, 1000Pcs/Tray, 4000Pcs/Carton.







12.Precaution

12.1 Immersion Soldering condition

ITEM	CONDITION	
Preheat temperature	110℃ Max (Ambient temperature of soldering surface of P.W.B)	
Preheat time 60s, Max		
Area of flux 1/2 Max of PWB Thickness		
Temperature of solder	260±5℃ 260±5℃	
Time of immersion	5±0.5s 5±0.5s	
Number of soldering	mber of soldering 2time Max (But should down heat of the first soldering)	
Printed wiring board Single side copper-clad laminates		

- (1) After switches were soldered, please be careful not to clean switches with solvent
- (2) Under the condition of using soldering iron, soldering temperature shall be 350°C±5°C with 3±0.5s.



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12.2 Notes

- (1) Please be cautious not to give excessive static load or shock to switches.
- (2) Please be careful not to stack up P. W. B. after switches were soldered.
- (3) Preservation under high temperature and high humidity or corrosive gas should be avoided Especially. When you need to preserve for a long period, do not open the carton.
- (4) The standard storage period is 3 months, with maximum up to 6months, preferably to be used as soon as possible. After opening the package, you should put the remaining switches in a plastic bag to prevent from damp and corrosive gas.
- (5) This Product Specification is considered as the technical agreement on product between the receiving customer and Kailh. Any information on Product Catalogue which is in conflict with or different from the corresponding information of this document is considered as invalid.
- (6) It will be considered that customer already confirmed and accepted this specification if customer issue purchase order to us directly.
 - (7) If there is no order or no request for new specification after 1 year upon this specification is issued, the specification will be regarded as invalid.
 - (8) Products meet the ROHS & REACH environmental management substances control standards